

## **Application Data Sheet**

### **Application Information**

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R??::

Number of CD disks::

Number of copies of CDs::

Sequence Submission::

Computer Readable Form (CRF)?::

Number of copies of CRF::

Title:: Polysilicon Layers Structure and Method of  
Forming Same

Attorney Docket Number:: 00939A-085300US

Request for Early Publication:: No

Request for Non-Publication:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 6

Small Entity?:: No

Latin name::

Variety denomination name::

Petition included?:: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers One::

Secrecy Order in Parent Appl.: No

### **Applicant Information**

Applicant Authority Type:: Inventor



099445-112601

Primary Citizenship Country:: Taiwan  
Status:: Full Capacity  
Given Name:: Kai-Cheng  
Middle Name::  
Family Name:: Chou  
Name Suffix::  
City of Residence:: San Jose  
State or Province of Residence:: CA  
Country of Residence:: US  
Street of Mailing Address:: 3661 Jasmine Circle  
City of Mailing Address:: San Jose  
State or Province of mailing address:: CA  
Country of mailing address:: US  
Postal or Zip Code of mailing address:: 95135

#### **Correspondence Information**

Correspondence Customer Number:: 20350

#### **Representative Information**

Representative Customer Number:: 20350

#### **Assignee Information**

Assignee Name:: Hynix Semiconductor, Inc.  
Street of mailing address:: San 136-1, Ami-ri, Bubal-eub, Ich'on-si  
City of mailing address:: Kyoungki-do, 467-701  
State or Province of mailing address::  
Country of mailing address:: Korea  
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